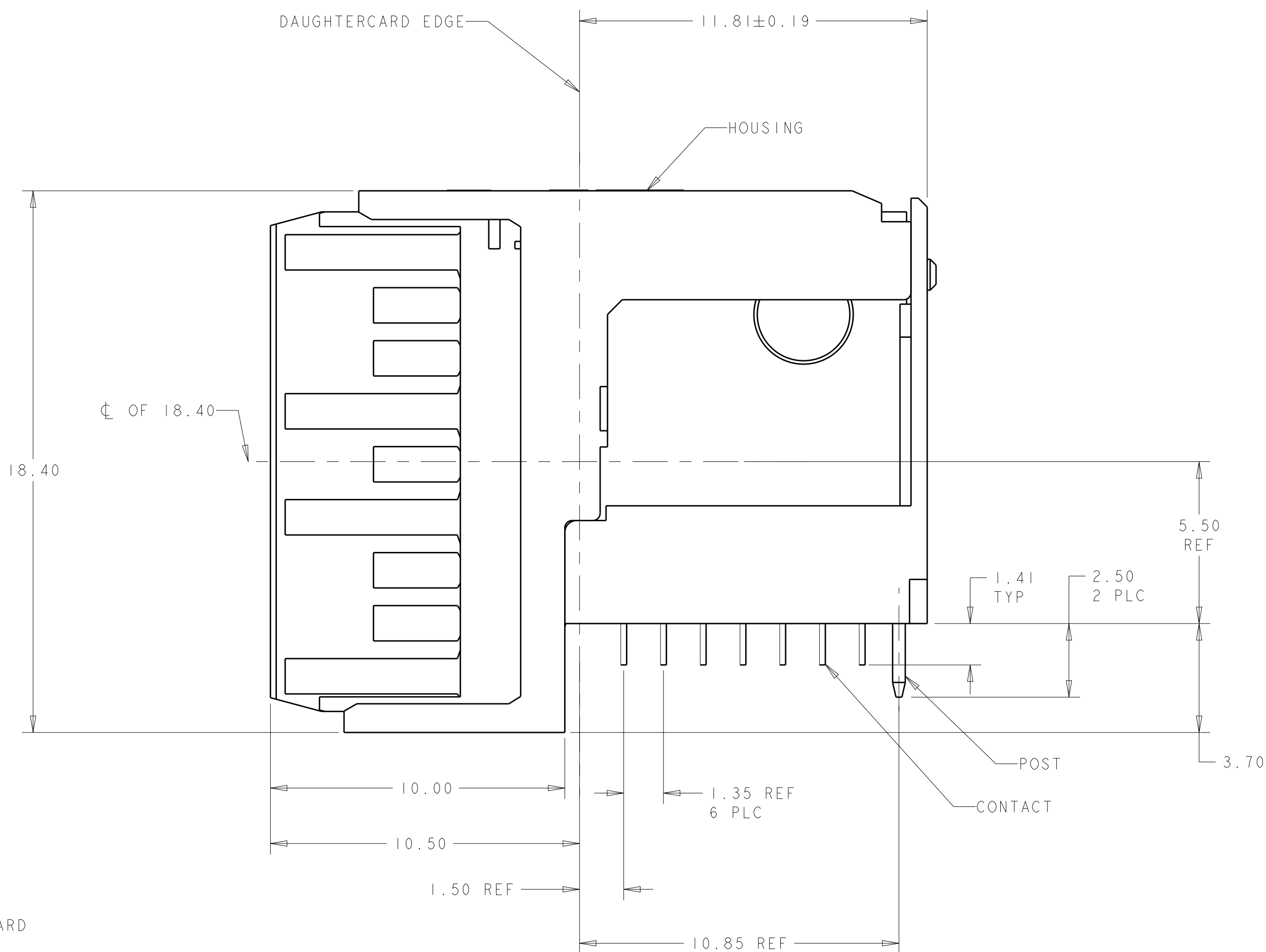


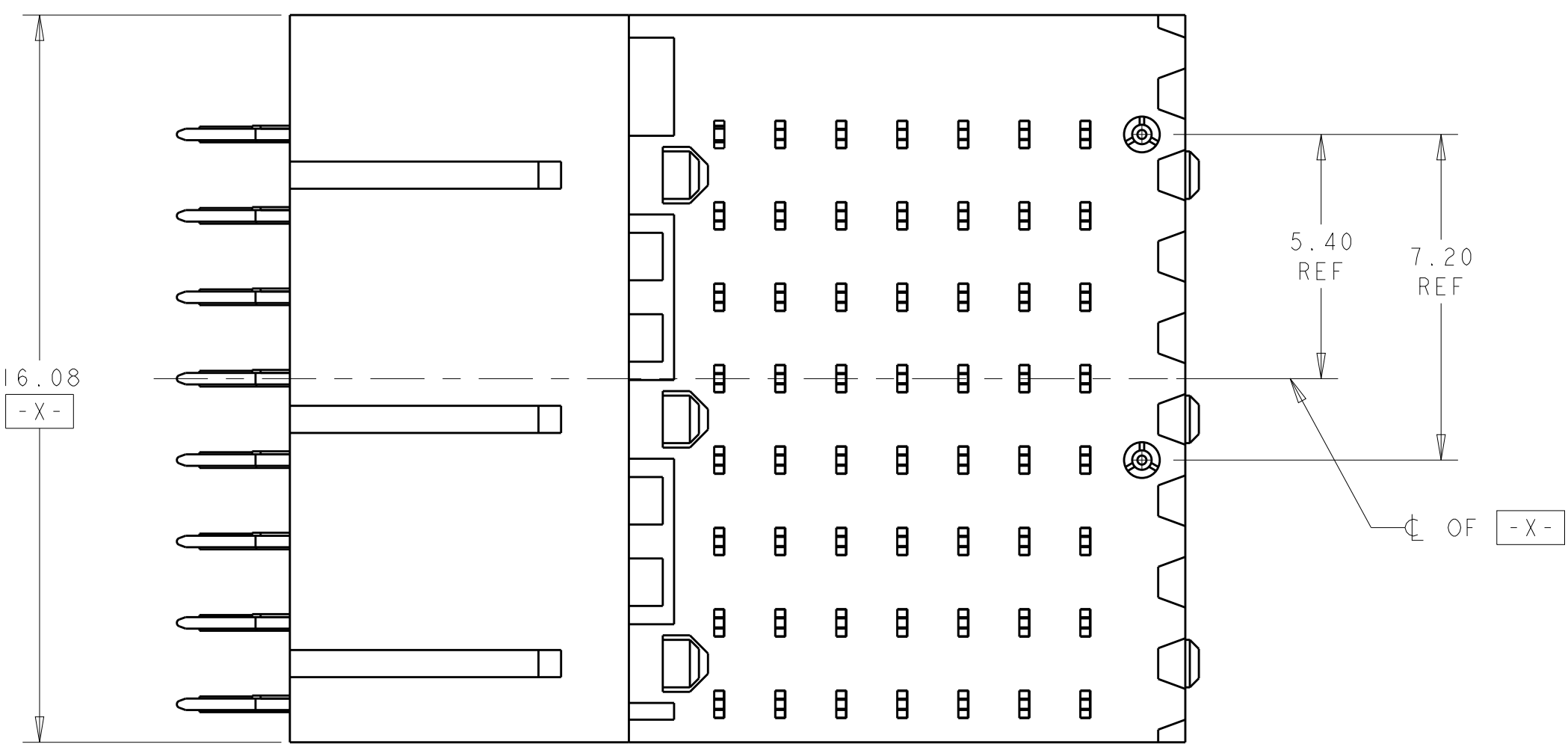


- ① HOUSING: LCP, UL94V0, COLOR: BLACK.
CONTACT: PHOSPHOR BRONZE.
POST: BRASS WIRE
- ② CONTACT: 1.27 μ m MIN GOLD IN PAD CONTACT AREA, 1.27 μ m MIN
TIN-LEAD ON PCB TAIL OVER 1.27 μ m MIN. NICKEL OVER ALL.
POST: 1.27 μ m MIN NICKEL PLATED.
- ③ PLATE THROUGH HOLE PER 114-13056,
FIGURE 4.
- ④ SEE TABLE I FOR INTERCONNECTIONS TO
BACKPLANE CONNECTOR.
- ⑤ CONTACT: 1.27 μ m MIN GOLD IN PAD CONTACT AREA
1.27 μ m MIN TIN ON PCB TAIL
OVER 1.27 μ m MIN NICKEL OVER ALL.
POST 1.27 μ m MIN NICKEL PLATED.

TABLE I
INTERCONNECTIONS WITH BACKPLANE CONNECTOR 1410186-1

TYPICAL INTERCONNECTIONS FOR EACH COLUMN (WAFER): 1,2,3,4,5,6,7,8		
CONTACT USAGE	DAUGHTERCARD CONNECTOR PIN	BACKPLANE CONNECTOR PIN
SIGNAL	ax	bx
SIGNAL	bx	cx
SIGNAL	dx	ex
SIGNAL	fx	gx
SIGNAL	gx	hx
GROUNDS	cx, ex, (ALL COMMONED)	ax, dx, fx, ix

NOTE: "x" DESIGNATES THE COLUMN NUMBER



	1410972-4
	1410972-3
PLATING	PART NO

[illegible]